**Features**

- International standard package
- Planar glassivated chips

I_{F(AV)} **60A**

Typical Applications

- High power rectifiers
- Field supply for DC motors
- Power supplies

V_{RRM} **1000~1600V**

I_{FSM} **600 A**

I²t **1800 A²s**

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{F(AV)}	Mean forward current	180° half sine wave 50Hz Double side cooled, T _c =100°C	175			60	A
I _{T(RMS)}	RMS on-state current					94	A
V _{RRM}	Repetitive peak reverse voltage	tp=10ms	175	1000		1600	V
I _{RRM}	Repetitive peak current	at V _{RRM}	175			10	mA
I _{FSM}	Surge forward current	10ms half sine wave V _R =0.6V _{RRM}	175			600	A
I ² t	I ² t for fusing coordination					1800	A ² s
V _{FO}	Threshold voltage		175			0.85	V
r _F	Forward slope resistance					2.3	mΩ
V _{FM}	Peak forward voltage	I _{FM} =180A	25			1.60	V
R _{th(j-c)}	Thermal resistance Junction to case	Clamping force 2.4kN				1.08	°C /W
M _s	To heatsink			2.4		2.9	N·m
T _{stg}	Stored temperature			-40		175	°C
T _{j(m)}	Junction temperature			-40		175	°C
W _t	Weight				15		g
Outline		ZL06、ZL06A					

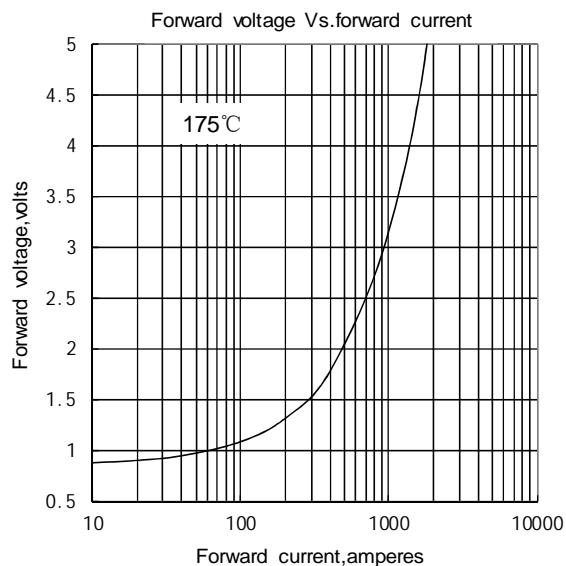


Fig.1

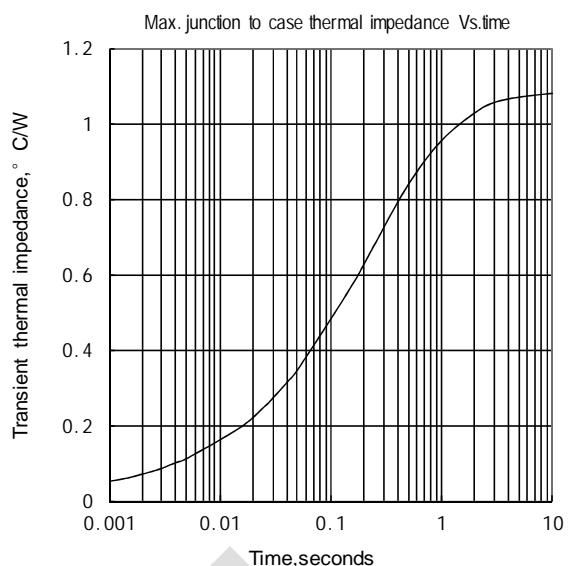


Fig.2

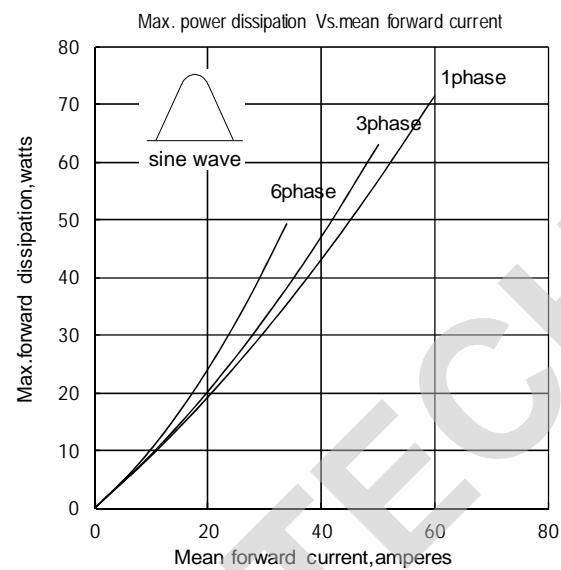


Fig.3

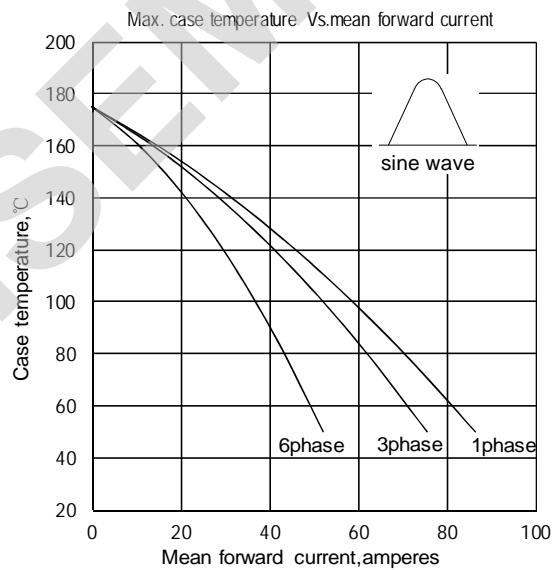


Fig.4

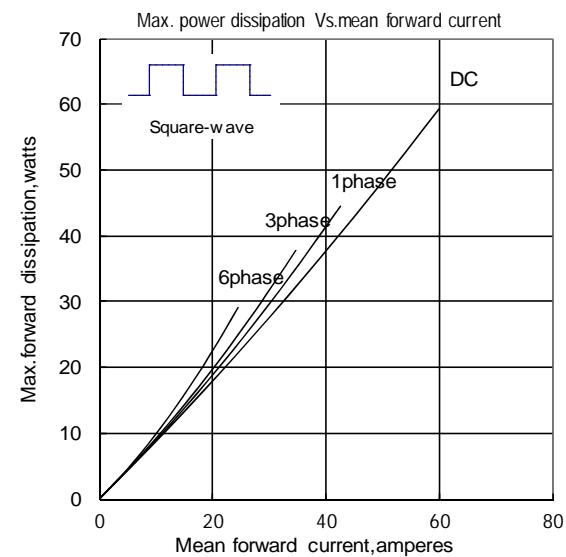


Fig.5

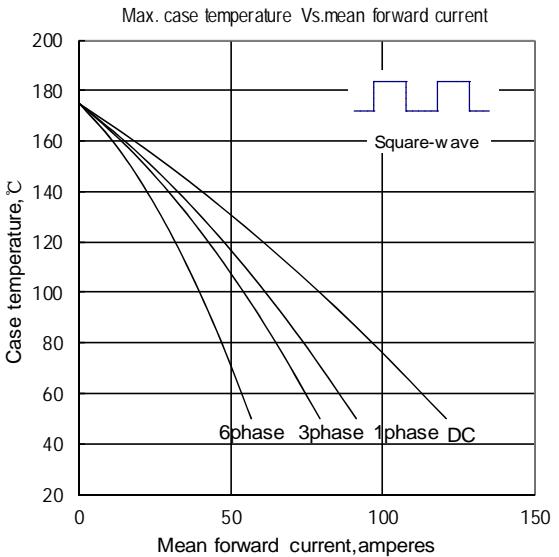


Fig.6

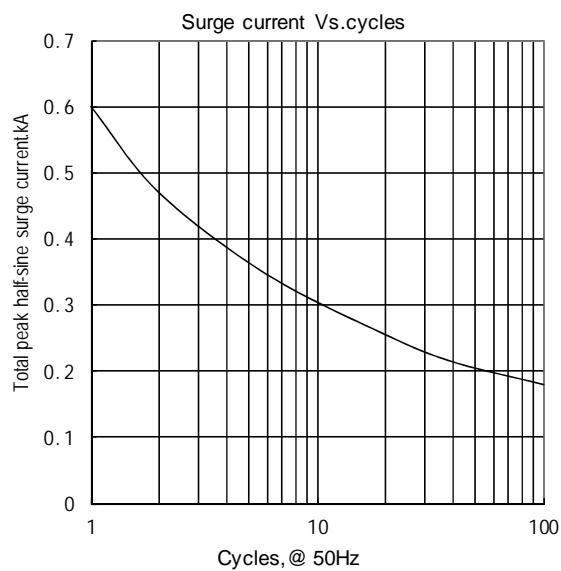


Fig.7

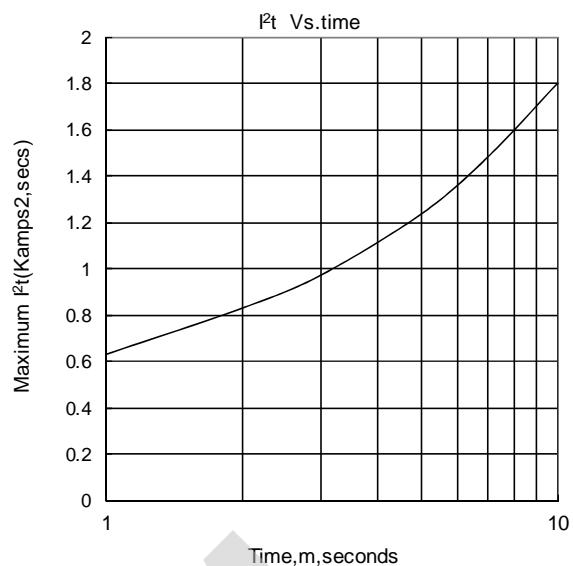
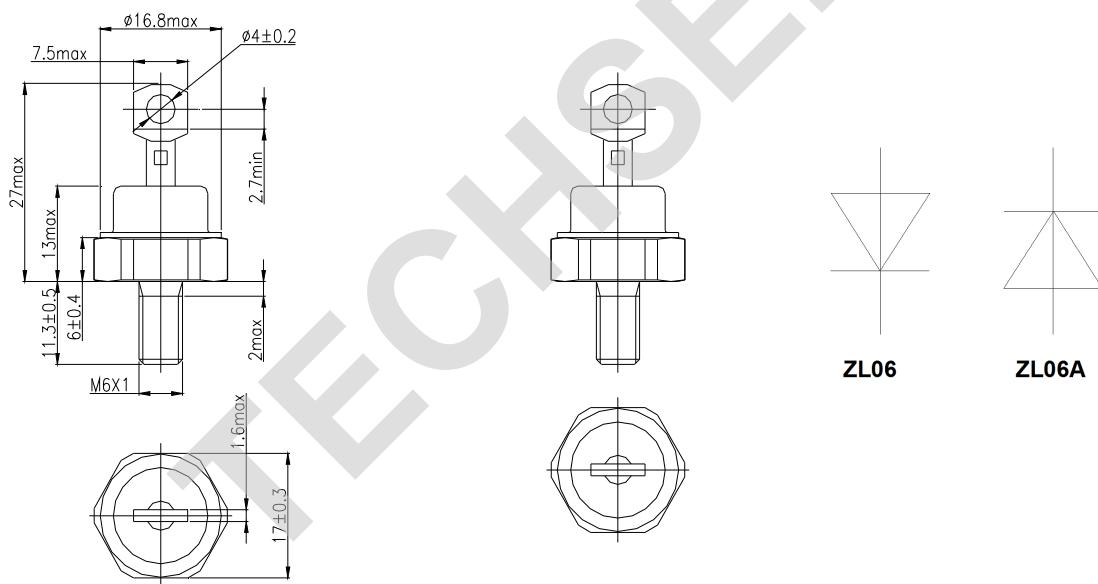


Fig.8

Outline:

TECHSEM reserves the right to change specifications without notice.